FAIRCHILD

SEMICONDUCTOR®

November 2013

FQU2N50B

N-Channel QFET[®] MOSFET

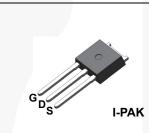
500 V, 1.6 A, 5.3 Ω

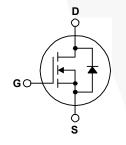
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 1.6 A, 500 V, $R_{DS(on)}$ = 5.3 Ω (Max.) @ V_{GS} = 10 V, I_D = 0.8 A
- Low Gate Charge (Typ. 6.0 nC)
- Low Crss (Typ. 4.3 pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter	FQU2N50BTU_WS	Units	
V _{DSS}	Drain-Source Voltage	500	V	
ID	Drain Current - Continuous ($T_C = 25^\circ$	1.6	A	
	- Continuous (T _C = 100	1.0	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	6.4	A
V _{GSS}	Gate-Source Voltage	± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	e Energy (Note 2) 120		mJ
I _{AR}	Avalanche Current	(Note 1)	1.6	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.0	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	4.5	V/ns
P _D	Power Dissipation ($T_A = 25^{\circ}C$) *	2.5	W	
	Power Dissipation ($T_C = 25^{\circ}C$)	30	W	
	- Derate above 25°C	0.24	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Ran	-55 to +150	°C	
ΤL	Maximum Lead Temperature for Solderin 1/8" from Case for 5 Seconds	ng,	300	°C

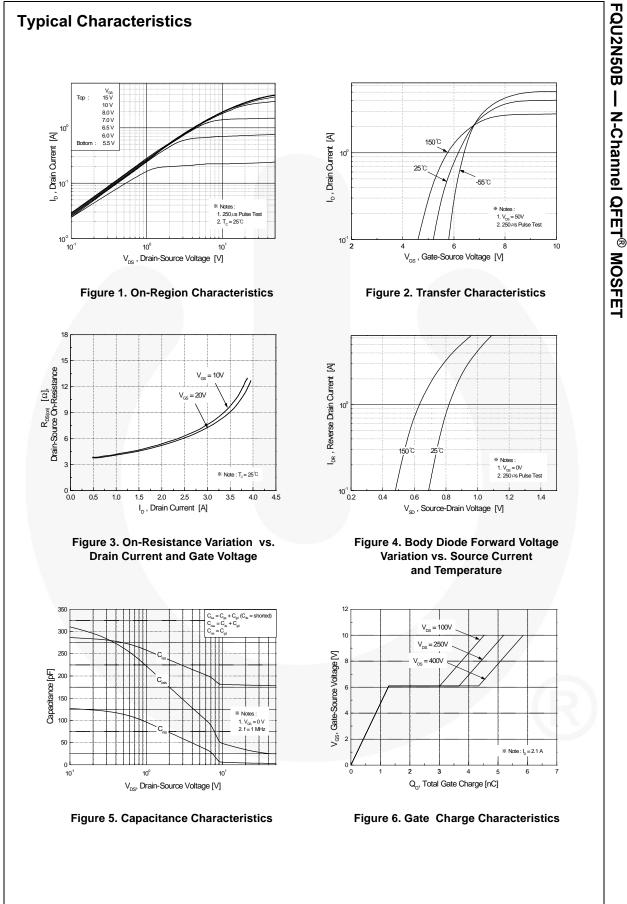
Thermal Characteristics

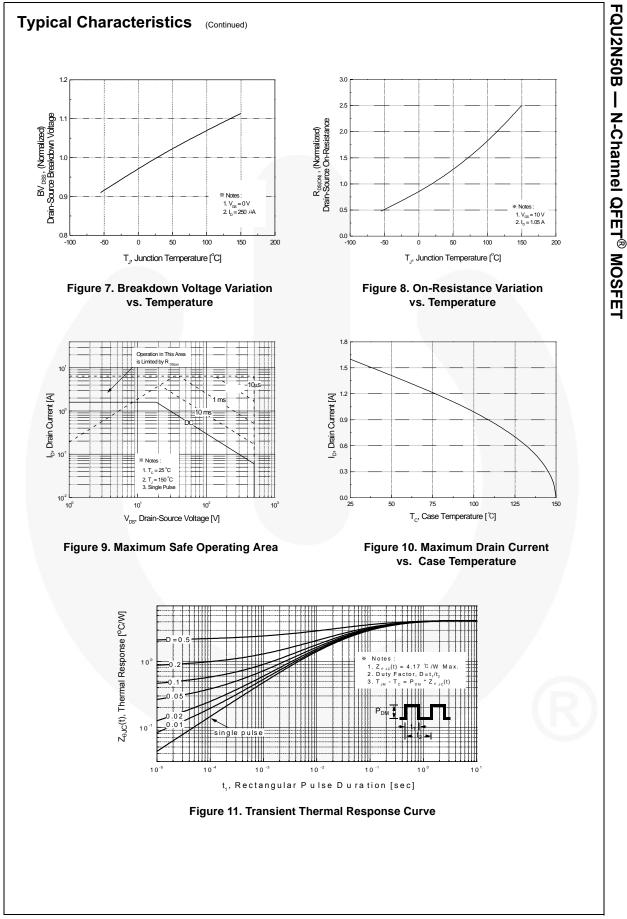
Symbol	Parameter	FQU2N50BTU_WS	Unit	
R_{\thetaJC}	Thermal Resistance, Junction to Case, Max.	4.17		
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	°C/W	
	Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max.	50		

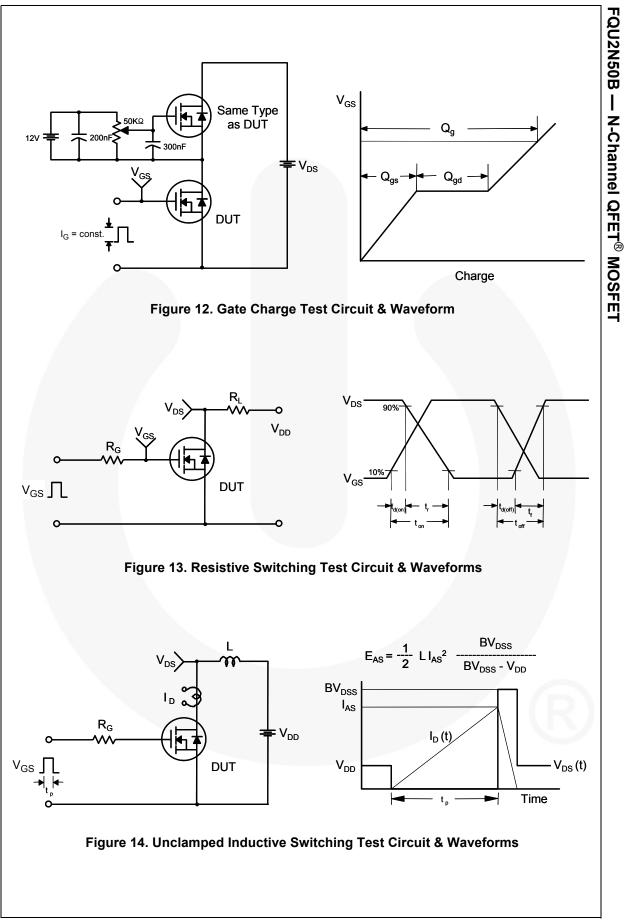
Part Number FQU2N50BTU_WS				age Packing Method Reel		Size	Tape Width N/A		Quantity 75 units	
				AK Tube N/						
lectri	cal Char	acteristics _{Tc}	= 25°C unless (otherwise noted.						
Symbol		Parameter		Test Cond	litions		Min	Тур	Max	Units
Off Cha	aracteristi	CS								
3V _{DSS}	Drain-Sour	ce Breakdown Volta	ge V.	V _{GS} = 0 V, I _D = 250 μA		500			V	
∆BV _{DSS} ∆T _J	Breakdown Voltage Temperature Coefficient		e I _D	$I_D = 250 \ \mu$ A, Referenced to 25°C				0.48		V/°C
DSS	Zero Gate Voltage Drain Current		V	$V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 400 \text{ V}, T_C = 125^{\circ}\text{C}$					1	μA
									10	μΑ
GSSF	Gate-Body	Leakage Current, Fo		$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$					100	nA
GSSR	Gate-Body	Leakage Current, R	everse V	_{GS} = -30 V, V _{DS} =	= 0 V				-100	nA
On Cha	racteristi	cs								
/ _{GS(th)}	Gate Thres	hold Voltage	V	_{DS} = V _{GS} , I _D = 2	50 µA		2.3	3.0	3.7	V
00()		0	V	$_{\rm DS}$ = V _{GS} , I _D = 28	50 mA		3.6	4.3	5.0	V
R _{DS(on)}	Static Drain On-Resista		V	_{GS} = 10 V, I _D = 0	.8 A		-	4.2	5.3	Ω
FS	Forward Tr	ansconductance	V	_{DS} = 50 V, I _D = 0	.8 A		ł	1.3		S
Dynam	ic Charac	teristics								
C _{iss}	Input Capa	citance	V	_{DS} = 25 V, V _{GS} =	0 V.			180	230	pF
Soss	Output Cap	acitance		= 1.0 MHz	,			30	40	pF
Prss	Reverse Tr	ansfer Capacitance						4	6	pF
Switchi	ing Chara	cteristics								
d(on)	Turn-On De		N	050.1/1	0.4.4			6	20	ns
r	Turn-On Ri	se Time		$_{DD} = 250 \text{ V}, \text{ I}_{D} =$	2.1 A,			25	60	ns
d(off)	Turn-Off De	elay Time	ĸ	_G = 25 Ω				10	30	ns
F	Turn-Off Fa				(Note 4)		20	50	ns
λ ^g	Total Gate	Charge	V	_{DS} = 400 V, I _D = 1	2.1 A.			6.0	8.0	nC
λ _{gs}	Gate-Source			_{GS} = 10 V	- ,			1.3		nC
2 _{gd}	Gate-Drain	Charge		~~	(Note 4)		3.0		nC
		ode Characteris	tice and	Maximum P	otinge					
s s		Continuous Drain-So			-				1.6	Α
SM	Maximum F	Pulsed Drain-Source	Diode Forw	ard Current					6.4	А
/ _{SD}		ce Diode Forward Vo		$_{\rm GS} = 0$ V, $I_{\rm S} = 1.6$	λ A				1.4	V
rr		ecovery Time	-	$rac{1}{100} = 0$ V, $I_S = 2.1$				195		ns
יי 2 _{יי}		ecovery Charge		₅ / dt = 100 A/μs				0.69		μC

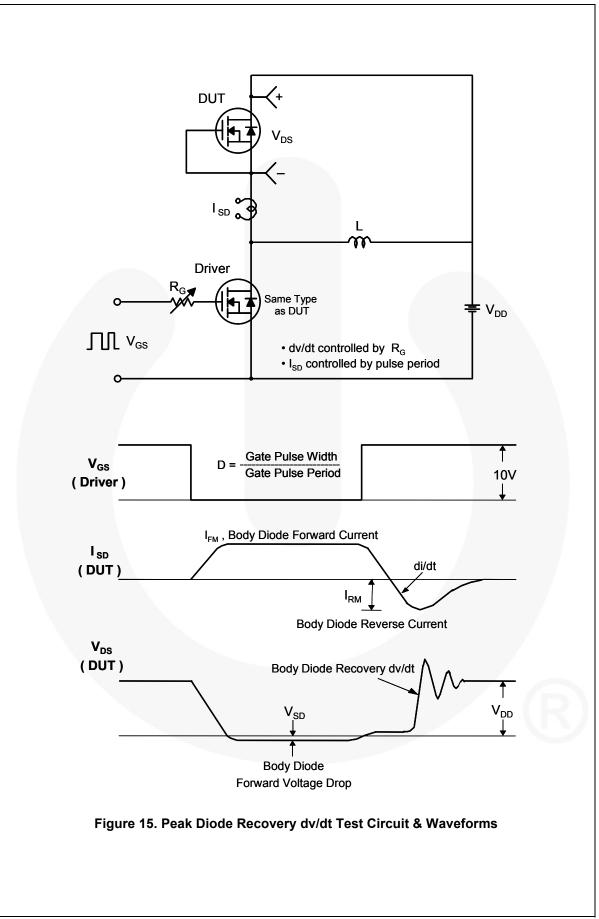
2. L = 85 mH, I_{AS} = 1.6 A, V_{DD} = 50 V, R_G = 25 Ω , starting I_J = 3. I_{SD} ≤ 2.1 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, starting T_J = 25°C. 4. Essentially independent of operating temperature.

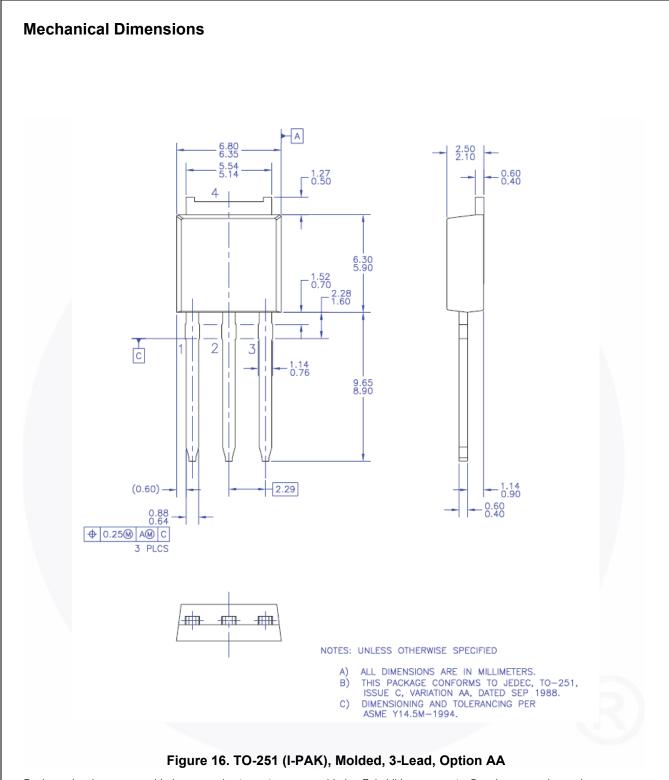
FQU2N50B — N-Channel QFET® MOSFET











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FQU2N50B — N-Channel QFET[®] MOSFET



Rev. 166

Advance Information

Preliminary

No Identification Needed

Obsolete

Formative / In Design

First Production

Full Production

Not In Production

notice to improve design.

Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.

Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without

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